

PAPER

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4, 6419Further insights into the Na_2WO_4 -assisted
synthesis method for WS_2 †Changyong Lan,^a Xinyu Jia,^a Yiyang Wei,^a Rui Zhang,^a Shaofeng Wen,^a
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Two-dimensional (2D) materials have become a hot topic in materials science, electronics, optoelectronics, and other fields. However, the practical applications of 2D materials rely heavily on the reliable synthesis of large-area, high-quality materials, which still poses a significant challenge. In this study, we present a detailed investigation into the Na_2WO_4 -assisted synthesis of WS_2 . Our findings reveal that the substrate temperature and the sequence and duration of introducing S vapor are critical factors in manipulating the morphology of the WS_2 products. Monolayer, thick film, and one-dimensional nanostructures can be obtained by varying the substrate temperature and the introduction sequence of S vapor. Furthermore, the introduction sequence and duration of S vapor can significantly impact the monolayer films' optical and electrical properties. Films synthesized with the introduction of S vapor before the evaporation of the W source exhibited strong photoluminescence (PL) emission, with a greater contribution from excitons. In contrast, films synthesized with the introduction of S vapor after the evaporation of the W source showed reduced PL emission, with a greater contribution from trions. Additionally, field effect transistors based on films synthesized with the introduction of S vapor before the evaporation of the W source displayed a larger threshold voltage and higher electron mobility. These findings suggest that the Na_2WO_4 -assisted synthesis method for WS_2 is highly controllable and pave the way for utilizing these monolayer WS_2 materials for technological applications.

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1. Introduction

Low dimensional materials have attracted wide attention in recent decades.^{1–7} Specifically, two-dimensional (2D) materials hold great promise for electronics and optoelectronics due to their exotic properties.^{8–14} Among many 2D materials, transition metal dichalcogenides (TMDs) are the most intensively studied semiconductor materials because of their suitable bandgap, and intriguing electronic and optoelectronic properties, such as layer-number dependent bandgap and band structure, strong light-matter interaction, and large carrier mobility.^{15–20} High-quality and large-area 2D materials are highly desirable for practical applications. To date, many efforts have been carried out for the controllable synthesis of wafer-scale 2D materials.^{21–23} Chemical vapor deposition (CVD)

is one of the most studied techniques owing to its possibility for wafer-scale and low-cost 2D material synthesis.^{24–27} For example, the Wang group, in collaboration with their colleagues, successfully synthesized wafer-scale single crystal monolayer and bilayer MoS_2 films using a CVD method with MoO_3 powder as the Mo source.^{28,29} Similarly, other TMDs, including MoSe_2 ,³⁰ and WS_2 ,^{31,32} can also be synthesized on a wafer scale using a CVD method with a solid metal source. However, restricted by the low vapor pressure of the solid metal source, controlling the optimal growth window, which is very narrow, remains a substantial challenge.

The utilization of molten salt has been demonstrated to effectively lower the melting point of metal oxide, leading to a significant increase in the vapor pressure of metal oxide, which facilitates the growth of various types of 2D materials.^{33–35} Recently, we have reported quasi-epitaxial growth of large single-domain monolayer WS_2 films on sapphire substrates by employing Na_2WO_4 .³⁶ Nevertheless, a comprehensive investigation of the growth parameters, particularly the substrate temperature and duration of introducing the S vapor, has yet to be conducted. In this study, we carried out a detailed investigation to study the impacts of substrate temperature, sequence, and duration of introducing S vapor on the growth behavior of WS_2 . We found that the substrate temperature, the S vapor

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introduction sequence, and duration are critical factors in manipulating the morphology of WS₂ products. Wire-like structures are obtained at low substrate temperatures *via* the vapor-liquid-solid mechanism. The high substrate temperature is beneficial for the formation of a continuous monolayer film. The duration of introducing S vapor can significantly impact the optical and electrical properties of the monolayer films. These findings suggest that the Na₂WO₄-assisted synthesis method for WS₂ is highly controllable and pave the way for utilizing these monolayer WS₂ materials for technological applications.

2. Results and discussion

The experimental setup of this study is illustrated in Fig. 1a. A horizontal tube furnace with two heating zones and an additional heating belt was utilized to investigate the effects of S vapor introduction sequence, duration, and deposition temperature on the growth behavior of WS₂. The temperature profile of the three heating zones is depicted as a function of time in Fig. 1b. In order to simplify the experiment, zone I was maintained at a constant temperature of 940 °C during deposition while the temperature of zone II was varied from 800 to 900 °C to examine its impact on the WS₂ growth. The heating belt was set to 150 °C during deposition, and its duration was adjusted to control the introduction of S vapor. The temperature distribution in zone II for different temperature settings is then presented in Fig. 1c. Zone II was divided into four subzones, labeled A, B, C, and D.

To begin with, we investigate the effects of introducing S vapor before the evaporation of the W precursor. At a lower substrate temperature of 800 °C, most of the resulting WS₂ products are deposited in subzone A, as observed on the corresponding substrates (Fig. 2a). The quantity of deposition materials decreases as the distance from zone I increases towards subzones B, C, and D. At a higher substrate temperature of 900 °C, a continuous film is formed in all four subzones.

Nonetheless, the continuous film exhibits numerous thick domains that increase in quantity with distance from zone I. At a medium temperature, the deposition quantity decreases in subzone A and increases in other subzones (Fig. 2b).

In zone I, WO₃ reacts with Na₂WO₄ to form Na_xWO_y, which is in a liquid state above approximately 700 °C.³⁷ At a temperature of 930 °C, Na_xWO_y vaporizes, forming a vapor. Prior to the evaporation of Na_xWO_y, S is introduced, which reacts with the evaporated Na_xWO_y to form WS₂ species. As a result, although some Na_xWO_y species may still be transported to zone II, most of the vapor species transported to this zone are WS₂ species. According to the classical nucleation theory, the driving force for nucleation is supersaturation. The chemical potential difference ($\Delta\mu$) between the deposited crystal and the vapor phase can be estimated by $\Delta\mu = kT\ln(s)$, where k is the Boltzmann constant, and T is the temperature in Kelvin. s is defined as P/P_{eq} , where P is the actual partial vapor pressure of WS₂, and P_{eq} is the saturation vapor pressure above the crystal.³⁸ The growth rate of the crystals is expected to vary linearly with s . The saturation vapor pressure P_{eq} is strongly related to temperature. Usually, P_{eq} depends exponentially on temperature, such that a small decrease in temperature leads to a significant reduction in P_{eq} and an increase in s . At a low deposition temperature of 800 °C, a large temperature gradient is observed in subzone A (Fig. 1c), resulting in the fast growth of WS₂ crystals. Additionally, the nucleus density is proportional to s , which explains why the thick deposition with small crystals is observed in subzone A. Because most of the source species are exhausted in subzone A, the source species transported downstream to zone II become scarce, reducing P and, subsequently, s . Consequently, the growth rate decreases, leading to sparser WS₂ flakes in the downstream side of zone II. This observation indicates that the growth of WS₂ at a low deposition temperature is limited by mass transport. As the deposition temperature increases, the temperature gradient decreases in subzone A, leading to a slower crystal growth rate. Accordingly, the growth of WS₂ in subzone A is less mass-transport limited. However, for a setting

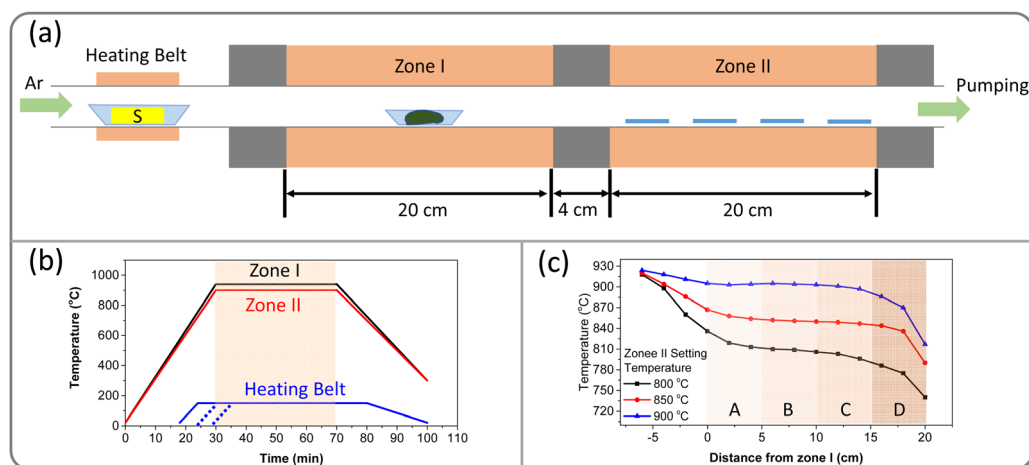


Fig. 1 Schematic of the setup and temperature profiles. (a) Schematic of the setup. (b) Temperature profiles for zone I, zone II, and the heating belt. (c) Temperature distribution in zone II.



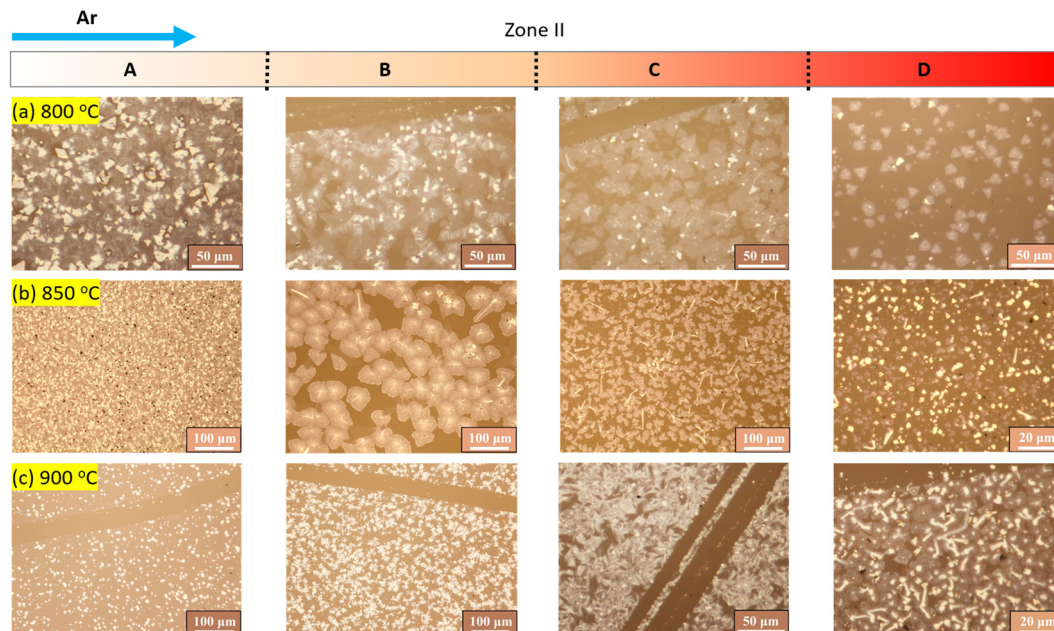


Fig. 2 Optical microscope images of the products obtained in zone II when S was heated before the evaporation of the W source. The temperatures of zone II are (a) 800 °C, (b) 850 °C, and (c) 900 °C.

temperature of 900 °C, the temperature gradient in subzones C and D becomes large, resulting in thick deposition in these areas.

Based on the above discussion, attaining a homogeneous temperature distribution is crucial for obtaining a uniform film. A setting temperature of 900 °C for zone II can achieve this homogeneity in subzones A and B. The homogeneous temperature distribution enables the production of a uniform monolayer film. However, thick domains observed in Fig. 2c may indicate overgrowth, which prompted an investigation into the time evolution of WS₂ growth at a temperature of 900 °C in zone II (Fig. 3). With a short growth time of 15 min, dispersed monolayer WS₂ triangles are observed in subzones A, B, and C, while subzone D shows a continuous film with thick domains and particles. The latter observation can be attributed to the

large temperature gradient in the subzone. When the growth time is increased to 25 min, a continuous monolayer film is formed in subzones A, B, and C. In contrast, a thick film was formed in subzone D. These results suggest that an appropriate growth time is critical for attaining the continuous monolayer WS₂ film in subzones A, B, and C. In any case, an excessively long growth time of 40 min leads to overgrowth, resulting in a film with numerous thick domains (Fig. 2c). This indicates that the growth of WS₂ is not fully self-limited, and defects in the monolayer WS₂ may act as nucleation sites for the overgrowth of WS₂.

Next, we investigate the impact of introducing S vapor after the evaporation of the W precursor. At a deposition temperature of 800 °C, most of the WS₂ crystals are deposited in subzone A, as shown in Fig. 4a. Increasing the temperature

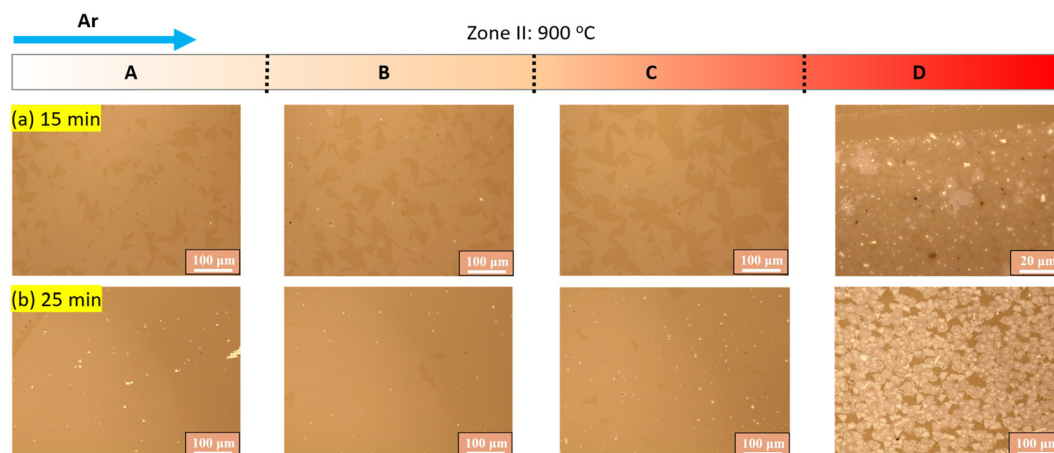


Fig. 3 Optical microscope images of zone II taken as a function of growth time. The temperature in zone II is set to be 900 °C.



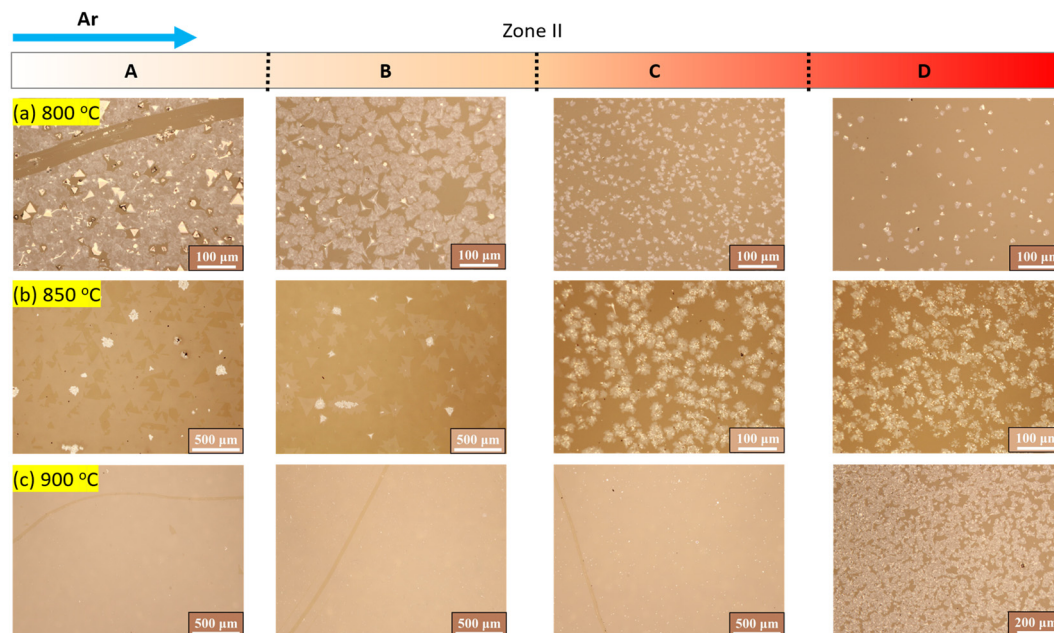


Fig. 4 Optical microscope images of the products obtained in zone II when S was heated after the evaporation of the W source. The temperatures of zone II are (a) 800 °C, (b) 850 °C, and (c) 900 °C.

to 850 °C would result in the observation of monolayer WS_2 flakes collected in subzone A, accompanied by a decrease in the quantity of the monolayer WS_2 in subzone B (Fig. 4b). In subzones C and D, thick flower-like WS_2 materials are witnessed. When the temperature of zone II is raised to 900 °C, the continuous monolayer WS_2 film can be obtained in subzones A, B, and C, but thick dispersed WS_2 domains are still present in subzone D (Fig. 4c).

At a temperature of 930 °C in zone I, Na_xWO_y vaporizes and is transported to zone II by the carrier gas. Without introducing the S vapor, liquid droplets of Na_xWO_y may form on the substrates in zone II. The deposition rate of these liquid droplets is linearly carried with s , where $s = P/P_{\text{eq}}$. Here, P is the actual partial pressure of Na_xWO_y , and P_{eq} is the saturation pressure above liquid Na_xWO_y . At a lower temperature of 800 °C, a large temperature gradient is formed in subzone A, resulting in the formation of numerous Na_xWO_y droplets on the substrate. When S vapor is introduced, the liquid droplets would react with S to form WS_2 crystals. These crystals aggregate later to form a thick WS_2 film. Since most of the Na_xWO_y species are deposited in subzone A, the amount of Na_xWO_y vapor transported downstream to subzones B, C, and D is significantly reduced, leading to a decrease in the product in those regions. When the temperature in zone II is increased to 850 °C, the density of Na_xWO_y droplets is reduced due to a decrease in the temperature gradient in subzone A. The reaction of the Na_xWO_y droplets with S vapor results in the formation of thick WS_2 crystals on the substrate, which act as nuclei for the monolayer WS_2 growth. The temperature gradient in subzone A is greater than in subzone B, resulting in a faster WS_2 growth rate in subzone A and larger monolayer WS_2 triangles. As the temperature gradient gradually increases, the

density of droplets in subzone C and subzone D increases, forming a flower-like product. When the temperature in zone II reaches 900 °C, a uniform monolayer WS_2 film forms in subzones A, B, and C, indicating the uniform deposition of WS_2 on the substrates. However, the large temperature gradient in subzone D would lead to thick WS_2 deposition. The above results and discussion indicate that achieving a uniform temperature distribution in the deposition zone is crucial for forming a uniform monolayer WS_2 film. Additionally, it is important to precisely control the growth time to prevent overgrowth.

Notably, introducing S at an appropriate time can lead to the formation of nanowires/nanobelts on substrates when the temperature of zone II is 850 °C, as shown in Fig. S1 (ESI†). Subzone A exhibits a thick WS_2 film due to a significant temperature gradient, while nanowires and nanobelts are observed in subzones B, C, and D. The formation of one-dimensional (1D) nanostructures *via* the vapor-liquid-solid (VLS) mechanism can be readily explained due to the formation of Na_xWO_y droplets on the substrate. In zone II, Na_xWO_y species are deposited onto the substrate as tiny droplets, reacting with the S vapor to form WS_2 that dissolves in the droplets. Upon reaching supersaturation, WS_2 is deposited onto the substrate through continuous deposition from the droplets, ultimately creating 1D WS_2 nanostructures. Previous studies have reported the growth of MoS_2 nanobelts on the NaCl substrate, with the formation of one-dimensional (1D) MoS_2 nanostructures attributed to the VLS mechanism.³⁹ Here, the construction of Na_xWO_y liquid droplets is critical to the growth of 1D WS_2 , and thus, S should be introduced after the formation of Na_xWO_y liquid droplets and not too late. Otherwise, tiny droplets will aggregate into larger ones that are too



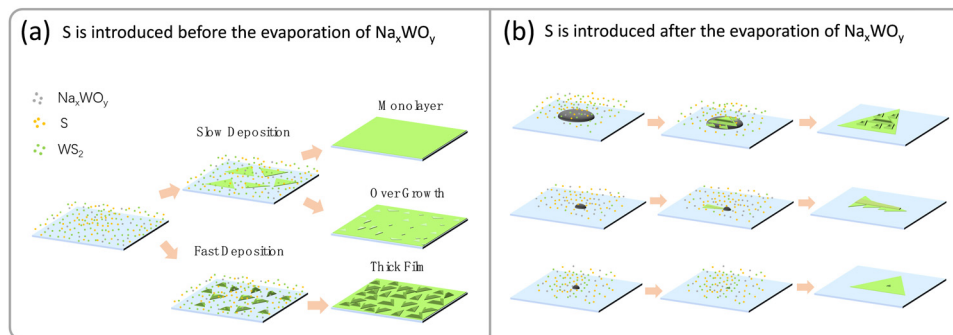


Fig. 5 Growth mechanism. (a) S is introduced before the evaporation of Na_xWO_y . (b) S is introduced after the evaporation of Na_xWO_y .

heavy for the deposited WS_2 to push away, forming only large crystals. Small Na_xWO_y liquid droplets can be formed accidentally in other synthesis conditions, resulting in the frequent observation of 1D-like WS_2 nanostructures in zone II (Fig. S2, ESI†).

Based on the obtained results, we propose mechanisms for the Na_2WO_4 -assisted growth of WS_2 , as illustrated in Fig. 5. When S is introduced before the evaporation of Na_xWO_y (Fig. 5a), most of the vapor species transported downstream are WS_2 . At high deposition temperatures, the deposition of WS_2 is slow, resulting in the growth of monolayer WS_2 triangles and, thus, a monolayer film. However, if the growth time is too long, overgrowth may occur on the defects or grain boundaries of the as-formed monolayer, leading to films with thick domains. At low deposition temperatures, the deposition of WS_2 is fast, leading to the growth of thick WS_2 triangles and, thus, a non-uniform thick WS_2 film. When S is introduced after the evaporation of Na_xWO_y (Fig. 5b), the vapor species transported downstream in the early stage is Na_xWO_y . The Na_xWO_y liquid droplets can form on the substrate, and when S is introduced, Na_xWO_y would react with S to form WS_2 species that can dissolve in the droplets. After supersaturation, WS_2

will deposit from the droplets. If the droplets are large enough, WS_2 will gradually deposit from them, forming large crystals. If the droplets are of adequate size, a VLS mechanism can occur, forming 1D WS_2 . If the droplets are too small, they will transform into WS_2 nanocrystals immediately upon reacting with S, which will act as the nuclei of monolayer WS_2 , forming a monolayer WS_2 film. In fact, most monolayer WS_2 triangle flakes exhibit a thick dot at their center (Fig. S3, ESI†). It is worth noting that the thick dots were consistently observed at the center of monolayer WS_2 triangles, regardless of the sequence and duration of the S introduction. This observation suggests the crucial role of the thick dot in the growth of monolayer WS_2 . In addition, the monolayer WS_2 film can be scaled up if a horizontal tube furnace with a larger diameter and longer heating zone is used, according to the growth mechanism.

To assess the quality of the monolayer film deposited at 900°C , Raman and PL spectroscopy were employed. The film synthesized with S introduction before the evaporation of the W source is labeled as sample #1, and the film synthesized with S introduction after the evaporation of the W source is labeled as sample #2. Both films exhibited similar Raman spectra (Fig. 6a),

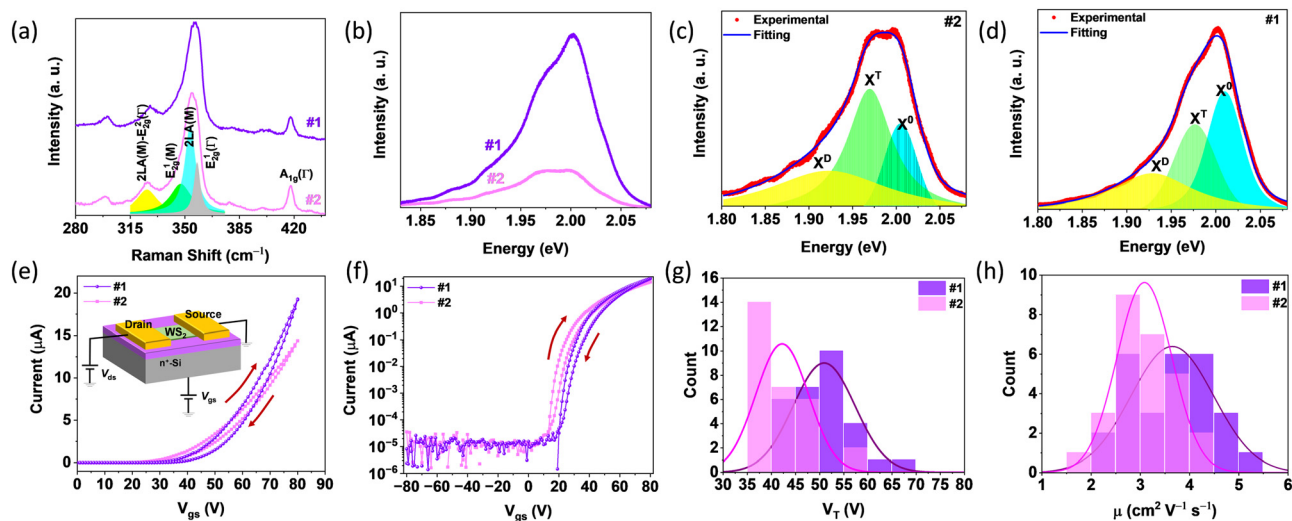


Fig. 6 Raman, PL spectra and electrical properties of WS_2 . (a) Raman spectra. (b) PL spectra. (c) PL spectrum of sample #1. (d) PL spectrum of sample #2. (e) Typical transfer curves. Inset: Schematic of the device structure. (f) Log-plot of the transfer curves. (g) Statistical diagram of the threshold voltage. (h) Statistical diagram of the electron mobility. The arrows in (e) and (f) indicate the sweeping directions during the measurements.

consistent with the monolayer WS₂.^{40,41} However, their PL spectra are different, as shown in Fig. 6b. The PL spectrum of sample #1 is stronger than that of sample #2, and the peak shapes are different. Deconvolution of the peaks (Fig. 6c and d) reveals three peaks corresponding to exciton (X^0 : ~ 2.01 eV), trion (X^T : ~ 1.98 eV), and defect-related emission (X^D : ~ 1.93 eV).⁴² The intensity ratios between X^0 and X^D are 1.38 and 0.42 for samples #1 and #2, respectively, indicating that the contribution from X^T is larger for sample #2. The formation of X^T is strongly related to the free electron concentration in WS₂, with higher concentrations contributing more to the PL emission.⁴³ Therefore, sample #2 has a higher free electron concentration. Though higher electron concentration is beneficial for the formation of trions, the overall possibility of the formation of both excitons and trions reduces, leading to the weak PL intensity for sample #2.⁴⁴ Intrinsic n-doping for WS₂ is commonly attributed to S vacancies,⁴⁵ inferring that the higher free electron concentration in sample #2 suggests a higher defect concentration overall. Due to the introduction of S vapor before the evaporation of Na₂WO₄ for sample #1, a reduced number of S vacancies is anticipated compared to sample #2, which is consistent with the observed PL results. These results suggest the high crystal quality of sample #1 in comparison with sample #2.

Back-gated field effect transistors (FETs) were fabricated to evaluate the electrical properties of the films. The structure of the devices is shown in the inset of Fig. 6e, SiO₂ with a thickness of 285 nm was used as the dielectric and n+-doped Si was used as the backgate electrode. Fig. 6e shows the typical transfer curves of FETs based on samples #1 and #2, indicating that both exhibit n-type conductivity as the drain-source current increases with the gate voltage. Both curves exhibit hysteresis due to the charge traps in the WS₂ channel, and/or in the interface between WS₂ and SiO₂.⁴⁶ Log plots of the transfer curves are presented in Fig. 6f to provide a better understanding of the FETs. Both FETs' current on/off ratio exceeds 10⁶, indicating a good device performance. Based on sample #1, the FETs display a larger threshold voltage than those based on sample #2, suggesting the higher n-doping in sample #2, consistent with the PL results. To further confirm this hypothesis, threshold voltages were extracted from tens of FETs, and the statistical diagrams are presented in Fig. 6g, which demonstrate that FETs based on sample #2 have a smaller threshold voltage. This result again indicates that sample #1 has a lower electron concentration than sample #2. The electron mobilities were extracted from the transfer curves, and the statistical diagrams are presented in Fig. 6h. FETs based on sample film #1 exhibit a higher average mobility, indicating better quality than sample #2, consistent with the observed PL results. Notably, both the threshold voltages and mobilities were extracted from the forward sweeping for simplicity. Due to the small hysteresis, the difference for forward and backward sweeping is small.

3. Conclusion

In summary, we have presented a detailed investigation into the Na₂WO₄-assisted synthesis of WS₂. Our findings reveal that

the substrate temperature and the sequence and duration of S vapor introduction are critical factors in tuning the morphology of the WS₂ products. A large-area, continuous monolayer film could be obtained with a suitable substrate temperature and growth time. A lower substrate temperature could lead to the formation of thick films, and wire-like nanostructures. Furthermore, the optical and electrical properties of the monolayer WS₂ film are closely related to the introduction sequence of S vapor. The film with the introduction of S before the evaporation of the W source showed a higher PL emission intensity, and FETs based on the film exhibited larger threshold voltages and higher electron mobilities. These findings suggest that the Na₂WO₄-assisted method for the growth of WS₂ is highly controllable and reproducible, and the obtained monolayer WS₂ films have a high quality, suitable for electronic applications.

4. Experimental section

Material synthesis

In the synthesis, a two heating zone horizontal furnace with a quartz tube was used. The mixture powder of WO₃ (99.9%) and Na₂WO₄ (99.9%) with a mass ratio of 1:2 was used as the W source. The mixture powder (0.1 g) was placed in a quartz boat, which was inserted in a quartz tube and placed in the center of zone I. Several pieces of sapphire substrates were placed in zone II. S powder (200 g) was placed in a corundum boat, which was placed on the upstream side of the quartz tube outside the heating zone of the furnace. S powder was heated by a heating belt. Before heating, the pressure inside the quartz tube was pumped to 1 Pa by a mechanical pump. Then Ar gas flow (200 sccm) was introduced into the quartz tube as a carrier gas. Typically, zone I and zone II were heated simultaneously. Zone I was heated to 930 °C for 30 min and held for 40 min; zone II was heated to 900 °C for 30 min and held for 40 min. S was heated to 150 °C for 6 min and held for 80 min. The pressure inside the quartz tube was maintained at ~ 120 Pa during the reaction. After the reaction, the furnace cooled down naturally.

Material characterizations

The morphology of the products was characterized by an optical microscope (Olympus, BX70). A Raman spectrometer (SR-5001-A-R, Andor) with a 532 nm laser was used to obtain Raman and PL spectra of the products.

Device fabrication

The as-synthesized products were transferred onto SiO₂ (285 nm)/Si substrate by the polystyrene-assisted transfer method.⁴⁷ Then, standard photolithography was used to define the channel areas. Ion-etching was used to etch the product outside the channel area. Standard photolithography was used again to define the drain and source electrode areas. Bi/Au (30/60 nm) were deposited as electrodes by vacuum thermal evaporation.



Device measurements

The performance of field effect transistors was measured in a vacuum probe station (PicoFemto). A semiconductor analyzer (B1500A, Keysight) was used to measure the output and transfer curves of the transistors. The pressure was maintained at $\sim 3 \times 10^{-4}$ Pa during the measurements. Constant current density ($10^{-2} \mu\text{A } \mu\text{m}^{-1}$) was used to extract the threshold voltage.

Conflicts of interest

There are no conflicts of interest to declare.

Acknowledgements

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